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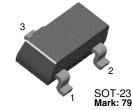
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### **MMBT4354**

### **PNP General Purpose Amplifier**

- This device is deisgned for use as general purpose amplifiers and switch requiring collector currents to 500mA.
- · Sourced from process 67.
- TN4033A for characteristics.



1. Base 2. Emitter 3. Collector

### **Absolute Maximum Ratings\*** T<sub>a</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V <sub>CEO</sub>	Collector-Emitter Voltage	-60	V
V <sub>CBO</sub>	Collector-Base Voltage	-60	V
V <sub>EBO</sub>	Emitter-Base Voltage	-5.0	V
I <sub>C</sub>	Collector Current - Continuous	-800	mA
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	- 55 ~ 150	°C

<sup>\*</sup> These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

- 1) These ratings are based on a maximum junction temperature of 150 degrees C.
  2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations

### Electrical Characteristics T<sub>a</sub>=25°C unless otherwise noted

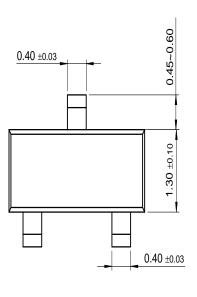
Symbol	Parameter	Test Condition	Min.	Max.	Units
Off Characte	eristics	•	-		
V <sub>(BR)CEO</sub>	Collector-Emitter Sustaining Voltage *	$I_C = -1.0 \text{mA}, I_B = 0$	-60		V
V <sub>(BR)CBO</sub>	Collector-Base Breakdown Voltage	$I_{C} = -10\mu A, I_{E} = 0$	-60		V
V <sub>(BR)EBO</sub>	Emitter-Base Breakdown Voltage	$I_E = -10\mu A, I_C = 0$	-5.0		٧
I <sub>CBO</sub>	Collector Cut-off Current	$V_{CB} = -50V, I_{E} = 0$		-50	nA
I <sub>EBO</sub>	Emitter Cut-off Current	$V_{EB} = -5.0V, V_{CE} = 0$		-10	μΑ
On Characte	eristics *	•			
h <sub>FE</sub>	DC Current Gain	$V_{CE} = -5V, I_{C} = -0.1 \text{mA}$ $V_{CE} = -5V, I_{C} = -1.0 \text{mA}$ $V_{CE} = -5V, I_{C} = -10 \text{mA}$ $V_{CE} = -5V, I_{C} = -100 \text{mA}$ $V_{CE} = -5V, I_{C} = -500 \text{mA}$	25 40 50 40 30	500	
V <sub>CE</sub> (sat)	Collector-Emitter Saturation Voltage	I <sub>C</sub> = -150mA, I <sub>B</sub> = -15mA I <sub>C</sub> = -500mA, I <sub>B</sub> = -50mA		-0.15 -0.50	V
V <sub>BE</sub> (sat)	Base-Emitter Saturation Voltage	I <sub>C</sub> = -150mA, I <sub>B</sub> = -15mA I <sub>C</sub> = -500mA, I <sub>B</sub> = -50mA		-0.9 -1.1	V V
V <sub>BE</sub> (on)	Base-Emitter On Voltage	$V_{CE} = -0.5V, I_{C} = -500mA$		-1.1	V
Small Signa	I Characteristics				
h <sub>fe</sub>	Small Signal Current Gain	I <sub>C</sub> = -50mA, V <sub>CE</sub> = -10V, f = 100MHz	1.0	5.0	
NF	Noise Figure	$V_{CE} = -10V$ , $I_{C} = -100\mu A$ $R_{S} = 1.0k\Omega$ , $f = 1.0KHz$ , $B_{W} = 1.0Hz$		2.0	dB
Switching C	haracteristics				
t <sub>on</sub>	Turn-On Time	I <sub>C</sub> = -500mA, V <sub>CC</sub> = -30V		100	ns
t <sub>off</sub>	Turn-Off Time	$I_{B1} = I_{B2} = -50 \text{mA}$		400	ns

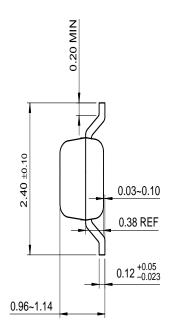
Thermal Characteristics T <sub>a</sub> =25°C unless otherwise noted			
Symbol	Parameter	Max.	Units
P <sub>D</sub>	Total Device Dissipation Derate above 25°C	350 2.8	mW mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

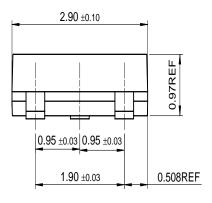
<sup>\*</sup> Device mounted on FR-4PCB 1.6" × 1.6" × 0.06".

## **Package Dimensions**

## SOT-23







Dimensions in Millimeters

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The Power Franch Programmable Act		PACMAN™ POP™	Stealth™ SuperSOT™-3	

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- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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#### **Definition of Terms**

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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